

Technical Data Sheet

MODEL NO: Q115ANR/ANY4

Features :

•Package in 8mm tape on 7" diameter reel

•Compatible with automatic placement equipment

•Compatible with reflow solder process

Applications:

Indicators

•Automotive : backlighting in dashboard and switch

•Backlight for LCD

Dice material	Emitted color	Lens Color
AlGaInP/GaAs	Red	
AlGaInP/GaAs	Yellow	Water transparent

Electrical/Optical Characteristics(Ta=25°C)

Parameter	Test	Symbol		Value			l lmit
	Condition			Min	Тур	Max	Unit
Spectral half bandwidth	IF=20mA	Δλ	R		19		nm
			Y		17		
Dominant wavelength	If=20mA	λD	R	630	640	650	nm
			Y	585	590	595	
Forward voltage	If=20mA	Vf	R	1.7	2.0	2.5	V
			Y	1.7	2.0	2.5	
	IF=20mA	lv	R	50	85	160	mcd
Luminous intensity			Y	100	170	320	
Viewing angle at 50% Iv	If=10mA	2 <i>0</i> 1/2			150		Deg
Reverse current	Vr=5V	lr				10	μΑ
						10	

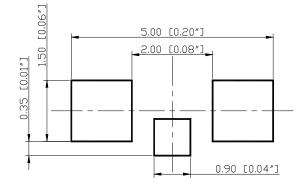


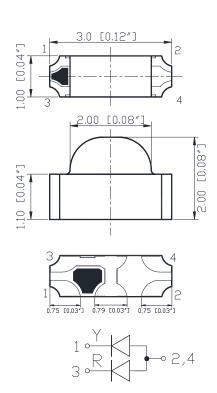
Absolute Maximum Ratings(Ta=25°C)

Parameter	Symbol	Value			Unit
		R	Y		
Power dissipation	Pd	75	75		mW
Forward current	lf	30			mA
Reverse voltage	Vr	5			V
Operating temperature range	Тор	-40 ~+80		°C	
Storage temperature range	Tstg	-40 ~+85		°C	
Peak pulsing current (1/8 duty f=1kHz)	IFP	125		mA	

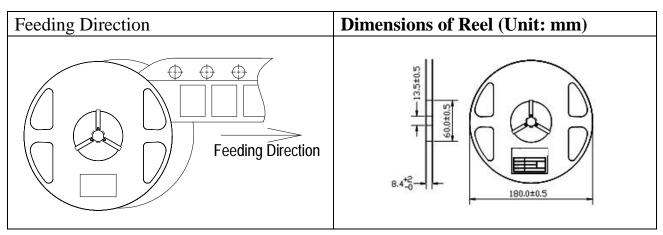
PACKAGING DIMENSIONS (mm):

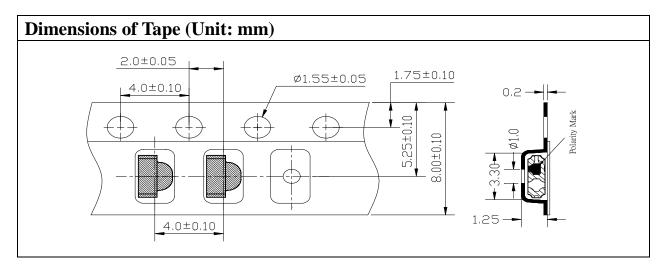
RECOMMEND PAD LAYOUT

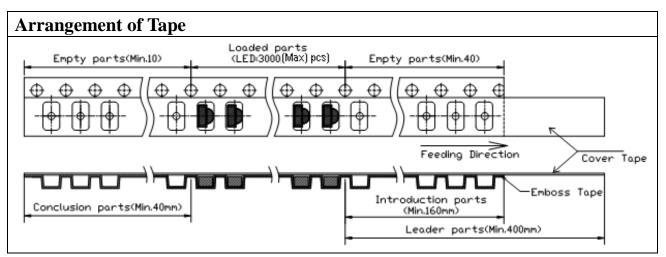












NOTES

- 1. Empty component pockets are sealed with top cover tape;
- 2. The maximum number of missing lamps is two;
- 3. The polarity mark is oriented towards the tape sprocket hole ;
- 4. 3,000(Max)pcs/Reel
- 5. .Packing will be multiple of 500, e.g 500pcs/R, 1000pcs/R, 1500pcs/R..etc , MAX 3000pcs/R



Precautions For Use :

Over – current – proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen)

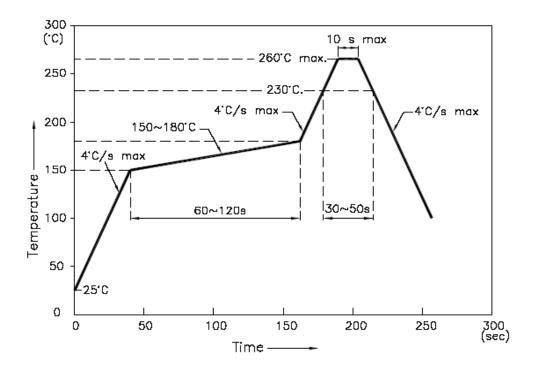
Storage

1. The operation of temperature and R.H. are $: 5^{\circ}$ C $\sim 30^{\circ}$ C, 60%R.H. Max.

2. Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a dampproof box with desiccating regent. Considering the tape life, we suggest our customers to use our products within 1.5 year (from production date).

3. It's recommended to bake before soldering when the package is unsealed after 72 hrs. The condition is : 60°C±5°C for 15hrs.

■ Reflow Temp/Time



NOTES:

- 1. We recommend the reflow temperature $245^{\circ}C(\pm 5^{\circ}C)$.the maximum soldering temperature should be limited to $260^{\circ}C$.
- 2. dont cause stress to the epoxy resin while it is exposed to high temperature.
- 3. Number of reflow process shall be 2 times or less.

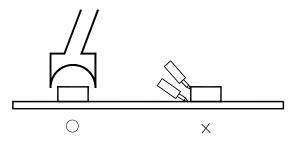


■Soldering iron

Basic spec is ≤ 5 sec when 260°C. If temperature is higher, time should be shorter (+10°C \rightarrow -1sec).Power dissipation of iron should be smaller than 20W, and temperatures should be controllable .Surface temperature of the device should be under 230°C .

Rework

- 1. Customer must finish rework within 5 sec under 260° C.
- 2. The head of iron can not touch copper foil
- 3. Twin-head type is preferred.



■ Avoid rubbing or scraping the resin by any object, during high temperature, for example reflow
solder etc.